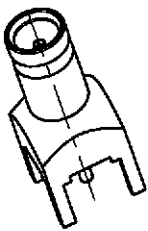
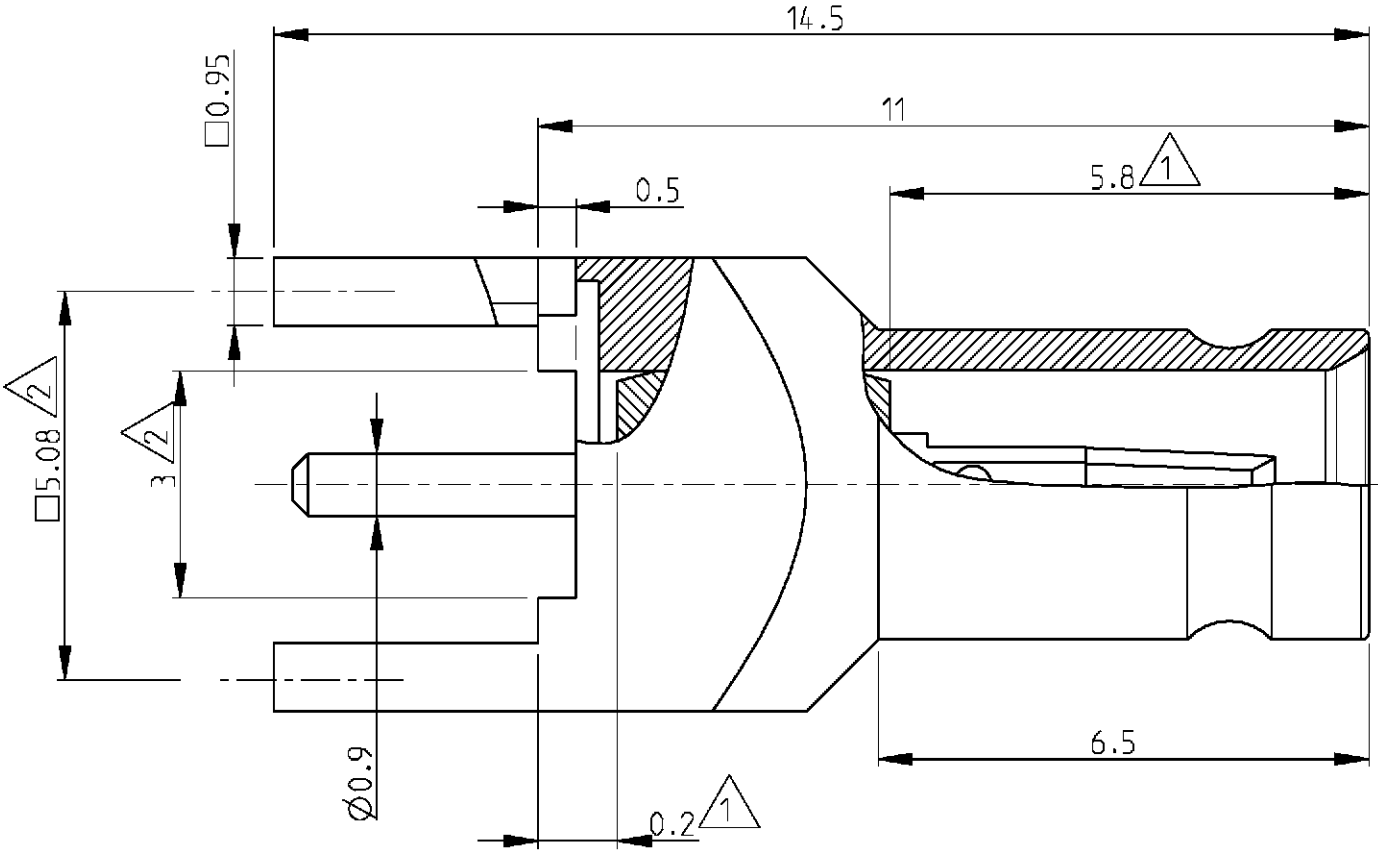
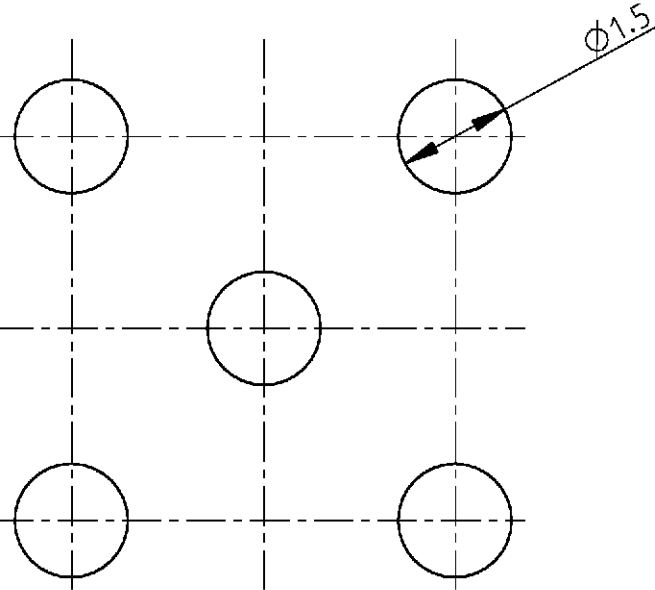


LOC	DIST	REVISIONS				
		P	LTR	DESCRIPTION	DATE	APVD
GW	-					
			A1	SR10-0138-01	5APR2001	CM



2:1

Recommended
PCB Layout
Pitch : 2.54



4. Mating face according to DIN 47297 and CECC 22230
3. Mounting requirements : PCB with pitch 2.54
Thickness : ± 3mm
Diameter of bores : Ø1.5 mm

- 2 Nominal dimension
- 1 Minimum dimension

All dimensions are maximum unless otherwise specified

V23600-A1027-C1	3-1393670-4	Dielectric	PTFE	
		Outer Con.	Brass	1µm Au min in contact area
		Center Con.	Cu Be	1µm Au min in contact area
Old Nr	Tyco Nr	Description	Material	Plating

THIS DRAWING IS A CONTROLLED DOCUMENT FOR TYCO ELECTRONICS CORPORATION IT IS SUBJECT TO CHANGE AND THE CONTROLLING ENGINEERING ORGANIZATION SHOULD BE CONTACTED FOR THE LATEST REVISION.		DWN MOROBE 15MAR2001	tyco Electronics		Tyco Electronics Oostkamp - Belgium	
		CHK MATTHEEUWS 3APR2001				
		APVD BOZZER 5APR2001	NAME		BULKHEAD JACK WITH PCB CONNECTION 1.0/2.3 50 Ohm	
DIMENSIONS: mm		TOLERANCES UNLESS OTHERWISE SPECIFIED:	PRODUCT SPEC		SIZE	
			APPLICATION SPEC		CAGE CODE	
			WEIGHT		DRAWING NO	
					RESTRICTED TO	
MATERIAL		FINISH			SCALE	
					SHEET	
					OF	
					REV	
					A1	